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SH7206 Group

Example of Transferring Data to an On-Chip Module Using the DMAC

Introduction

This application note describes an example of data transfer to an on-chip module using the direct memory access controller (DMAC) in the SH7206.

Target Device

SH7206

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1. Overview

1.1 Specifications

- Using the DMAC channel 1, data is transferred from external memory to the transmit FIFO data register (SCFTDR) of the serial communication interface with FIFO (SCIF channel 0), and thus character strings are sent.
- The transmit-FIFO-data-empty transfer request (a request from on-chip peripheral module) of the SCIF is used as the DMA transfer request.

1.2 MCU Functions Used

- Direct memory access controller (DMAC channel 1)
- Serial communication interface with FIFO (SCIF channel 0)

1.3 Conditions for Application

- MCU: SH7206 (R5S72060)
- Operating frequency: Internal clock: 200 MHz
Bus clock: 66.67 MHz
Peripheral clock: 33.33 MHz
- C compiler: SuperH RISC Engine Family C/C++ Compiler Package: version 9.00
(from Renesas Technology Corp.)
- Compiler options: Default setting of HEW (-cpu = sh2a -debug -gbr = auto -global_volatile = 0
-opt_range = all -infinite_loop = 0 -del_vacant_loop = 0
-struct_alloc = 1)

1.4 Related Application Note

- The operation of the sample program in this application note was confirmed with the configuration specified in the application note "Example of SH7206 Initial Configuration". Please refer to that note in combination with this one.
- Details on SCIF UART transmission are described in the SH7206 application note "Example Settings for UART Transmission by the SCIF".

2. Description of Sample Application

This sample application applies the direct memory access controller (DMAC) to transfer of data from external memory to the SCIF in response to an on-chip peripheral module request.

2.1 Summary of MCU Functions Used

When DMA transfer requests are generated, the DMAC initiates transfer in accordance with the priority levels assigned to its channels, and terminates the transfer when the transfer-end conditions are satisfied. There are three transfer request modes: auto request, external request and on-chip peripheral module request. Either burst mode or cycle-steal mode can be selected as the bus mode.

Table 1 summarizes the features of the DMAC. Figure 1 is a schematic view of the DMAC.

Table 1 Summary of the DMAC

Item	Function
Number of channels	8 (CH0 to CH7) Of these, four channels CH0 to CH3 can receive external requests.
Address space	4 Gbytes
Transfer data sizes	Byte, word (2 bytes), longword (4 bytes), and 16 bytes (longword × 4)
Maximum transfer count	16,777,216 (24 bits)
Address modes	Single-address mode and dual-address mode
Transfer requests	Auto request, external request, and on-chip peripheral module request (SCIF: 8 sources, IIC3: 2 sources, ADC: 2 sources, MTU2: 5 sources, CMT: 2 sources)
Bus modes	Cycle-steal mode and burst mode
Channel priority	Fixed mode and round-robin mode
Interrupt request	An interrupt is requested to the CPU upon completion of half- or full-data transfer.
External request detection	Detection of low or high level of the DREQ input, or rising or falling edge of the DREQ input
Transfer request acknowledge signal/transfer end signal	Selectable active levels of DACK and TEND signals

Note: For details on the DMAC, refer to section 9, Direct Memory Access Controller, of the SH7206 Group Hardware Manual.

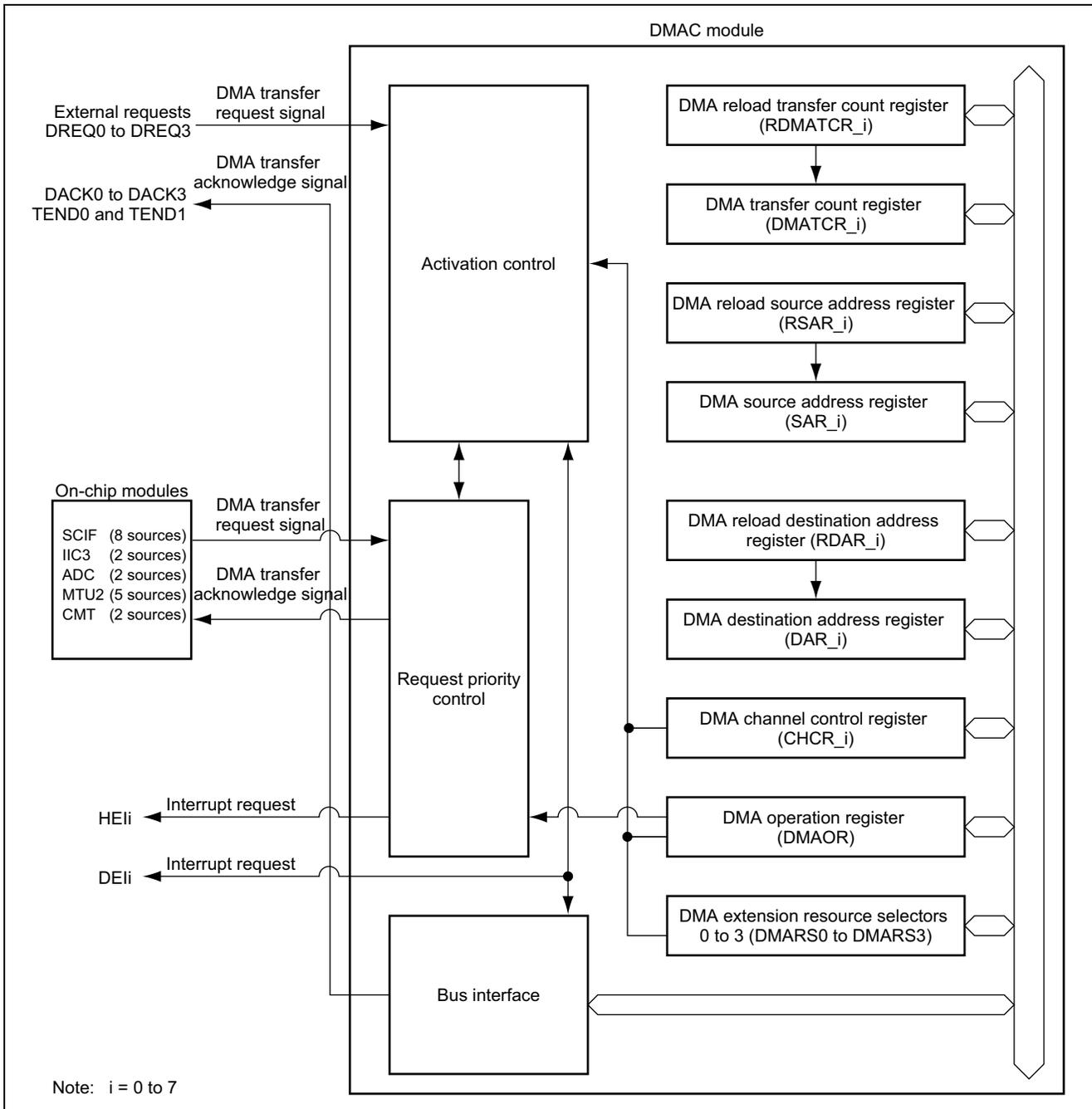


Figure 1 Schematic View of the DMAC

2.2 Procedure for Setting the MCU Modules

This section describes the initial setting procedure for data transfer from memory to the on-chip peripheral module by the DMAC in response to a transfer request form an on-chip peripheral module. Figure 2 shows an example flow of making initial settings of the DMAC. For details on the settings of individual registers, refer to the SH7206 Group Hardware Manual.

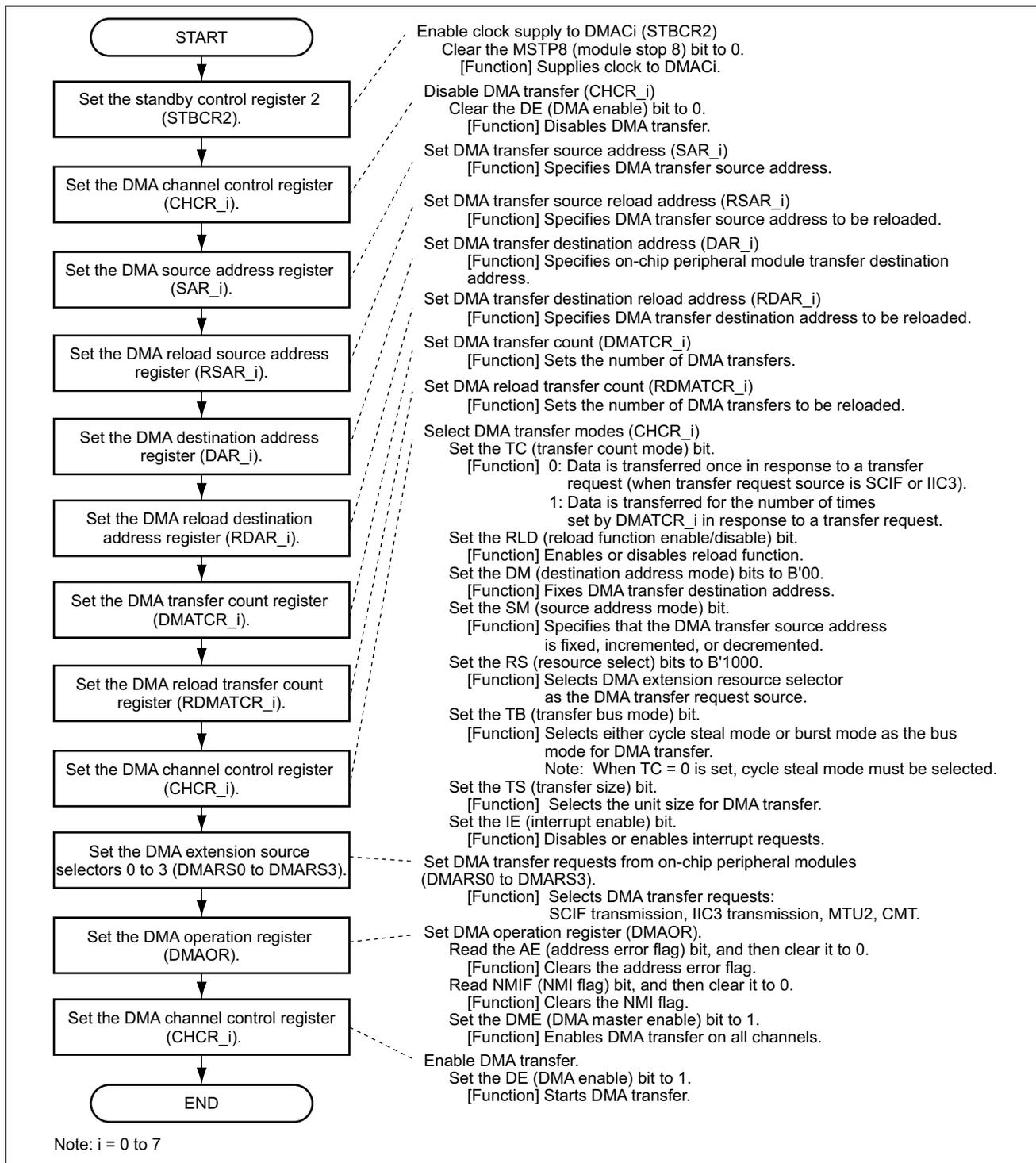


Figure 2 Example Flow for Initial Settings of the DMAC

2.3 Operation of Sample Program

In the sample program, channel 1 of the DMAC is activated in response to a transmit-FIFO-data-empty transfer request (on-chip peripheral module request) from the SCIF, and data are transferred from external memory to the transmit FIFO data register (SCFTDR) of the SCIF channel 0. The data written to the SCFTDR register is transmitted in UART mode.

Figure 3 illustrates the timing of the sample program operation.

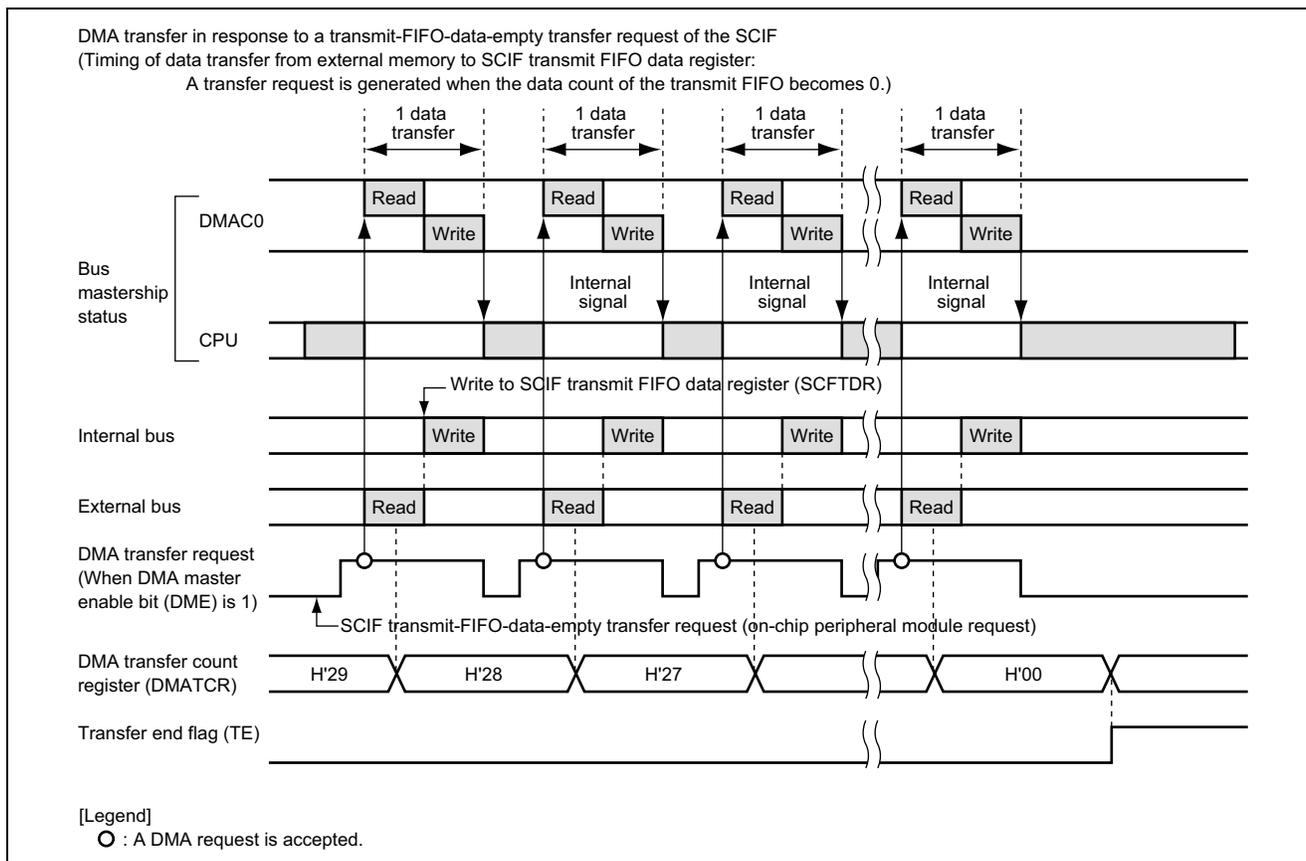


Figure 3 Timing of Sample Program Operation

2.4 Register Settings and Processing Sequence of Sample Program

In the sample program, character string data stored in external memory is transferred to the transmit FIFO data register (SCFTDR) of the SCIF channel 0 by DMA transfer. The data is then transmitted in UART mode.

The register settings of the sample program are shown in table 2, macro definitions used in the sample program is listed in table 3, and processing flow of the sample program is shown in figure 4.

Table 2 Register Settings in the Sample Program

Register Name	Address	Setting	Description
Standby control register 2 (STBCR2)	H'FFFE0018	H'00	MSTP8 = 0: The DMAC runs.
DMA channel control register_1 (CHCR_1)	H'FFFE101C	H'00000000	DE = 0: DMA transfer is disabled.
		H'00001800	TC = 1: Transfer once in response to each DMA request. RLD = 0: Reload function is disabled. DM = B'00: Destination address is fixed. SM = B'01: Source address is incremented. RS = B'1000: Extension resource selector TB = 0: Cycle-steal mode TS = B'00: Byte transfer IE = 0: Interrupt requests are disabled.
		H'00001801	DE = 1: DMA transfer is enabled
DMA source address register_1 (SAR_1)	H'FFFE1010	Address of character string data	Transfer source start address: Start address of character strings stored in external memory.
DMA destination address register_1 (DAR_1)	H'FFFE1014	H'FFFE800C	Transfer destination start address: Address of the SCIF transmit FIFO data register_1 (SCFTDR_1).
DMA transfer count register_1 (DMATCR_1)	H'FFFE1014	Number of bytes in character string data	Transfer count: Number of bytes in the character string data
DMA extension resource selector (DMARS0)	H'FFFE1300	H'0081	MID = B'100000 RID = B'01: A transmit-FIFO-data-empty transfer request of SCIF_0 is specified.
DMA operation register (DMAOR)	H'FFFE1200	H'0001	DME = 1: DMA transfer is enabled on all channels.

Table 3 Macro Definitions Used in the Sample Program

Macro Definition	Setting	Description
DMA_SIZE_BYTE	H'0000	Byte transfer
DMA_SIZE_WORD	H'0001	Word transfer
DMA_SIZE_LONG	H'0002	Longword transfer
DMA_SIZE_LONGx4	H'0003	16-byte transfer
DMA_INT_DISABLE	H'0000	DMA transfer end interrupt is not used
DMA_INT_ENABLE	H'0010	DMA transfer end interrupt is used

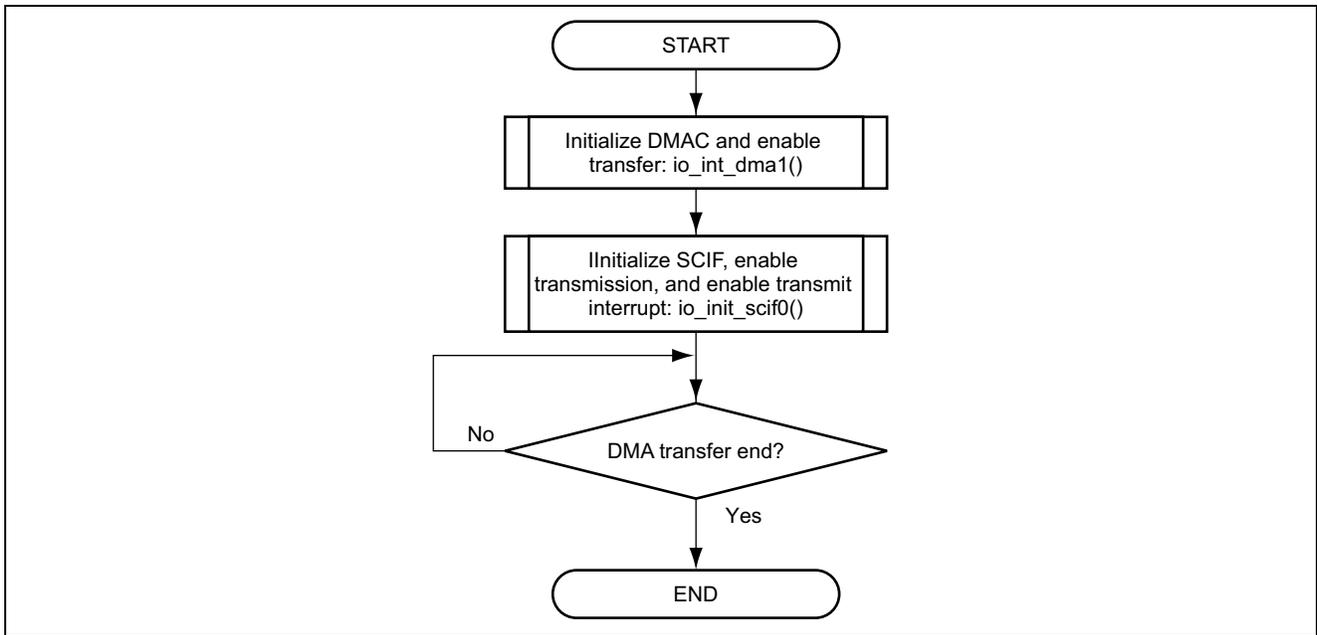


Figure 4 Processing Flow of the Sample Program

3. Sample Program Listing

1. Sample Program Listing: main.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name: SH7206 Sample Program
4  *   File Name   : main.c
5  *   Version    : 1.00.00
6  *   Contents   : DMAC sample program
7  *   Model     : M3A-HS60
8  *   CPU       : SH7206
9  *   Compiler  : SHC9.0.00
10 *
11 *   Note       : Sample program for transferring data from the SCIF by DMAC1
12 *
13 *               <Caution>
14 *               This sample program is for reference
15 *               and its operation is not guaranteed.
16 *               Customers should use this sample program for technical reference
17 *               in software development.
18 *
19 *   COPYRIGHT (C) 2004 RENESAS TECHNOLOGY CORP. ALL RIGHTS RESERVED
20 *   AND RENESAS SOLUTIONS CORP. ALL RIGHTS RESERVED
21 *
22 *   history    : 2004.10.28 ver.1.00.00
23 *"FILE COMMENT END"*****
24 #include <string.h>
25 #include "iodefine.h"                /* iodefine.h is automatically created by HEW      */
26
27 /* ==== Macro declarations ==== */
28 /* ==== DMAC setting ==== */
29 #define DMA_SIZE_BYTE    0x0000u
30 #define DMA_SIZE_WORD   0x0001u
31 #define DMA_SIZE_LONG   0x0002u
32 #define DMA_SIZE_LONGx4 0x0003u
33 #define DMA_INT_DISABLE 0x0000u
34 #define DMA_INT_ENABLE  0x0010u
35 #define DMA_INT         (DMA_INT_ENABLE >> 4u)
36
37 /* ==== Prototype declarations ==== */
38 void main(void);
39 void io_init_dmal (void *src, void *dst, size_t size, unsigned int mode);
40 void io_dmal_stop (void);
41 void io_init_scif0(int);
42
43 /* ==== Type declaration ==== */
44 /* SCIF baud rate setting */
45 typedef struct {
46     unsigned char scbrr;
47     unsigned short scsmr;
48 } SH7206_BAUD_SET;
49
50 /* ---- Values for baud rate specification ---- */
51 enum{
52     CBR_1200,
53     CBR_2400,
54     CBR_4800,
55     CBR_9600,
56     CBR_19200,
57     CBR_31250,
58     CBR_38400,
59     CBR_57600,
60     CBR_115200
61 };
62

```

2. Sample Program Listing: main.c (2)

```

63  /* ==== Table of register setting values ==== */
64  static SH7206_BAUD_SET scif_baud[] = {
65      {214, 1},          /* 1200bps (-0.07%) */
66      {106, 1},         /* 2400bps ( 0.39%) */
67      {214, 0},         /* 4800bps (-0.07%) */
68      {106, 0},         /* 9600bps ( 0.39%) */
69      { 53, 0},         /* 19200bps (-0.54%) */
70      { 32, 0},         /* 31250bps ( 0.00%) */
71      { 26, 0},         /* 38400bps (-0.54%) */
72      { 17, 0},         /* 57600bps (-0.54%) */
73      {  8, 0},         /*115200bps (-0.54%) */
74  };
75
76  /* Character string to be transmitted */
77  const signed char data[] = "SCIF request DMAC Sample Software SH7206.\r\n";
78
79  /*"FUNC COMMENT"*****
80  * ID
81  * Module summary: Main function of the sample program (UART transmission with use of DMAC)
82  *-----
83  * Include      : #include <string.h>
84  *-----
85  * Declaration  : void main(void)
86  *-----
87  * Functional description:
88  *              : The character string data stored in external memory is DMA transferred
89  *              : to the SCIF transmit FIFO data register. The DMAC is activated
90  *              : by an SCIF transmit interrupt request.
91  *-----
92  * Argument     : None
93  *-----
94  * Return value : None
95  *-----
96  * Notes        :
97  *"FUNC COMMENT END"*****/
98  void main(void)
99  {
100     /* ==== Enabling DMAC initialization/transfer ==== */
101     io_init_dmal(data, (void *)&SCIF0.SCFTDR.BYTE ,sizeof(data),
102     DMA_SIZE_BYTE | DMA_INT_DISABLE);
103     /* On-chip peripheral module request (SCIF transmit interrupt request) */
104     /* Data transfer from external memory to SCIF transmit */
105     /* FIFO data register */
106
107     /* ==== Initialization of SCIF0/enabling transmission ==== */
108     io_init_scif0(CBR_115200);
109     /* Communication mode: UART mode */
110     /* Bit rate: 115.2 kbps */
111     /* TXI interrupt is generated when data in transmit FIFO is one byte */
112
113     /* ==== Disabling DMA transfer ==== */
114     io_dmal_stop();
115
116     while(1){
117         /* End of program */
118     }
119
120 }

```

3. Sample Program Listing: main.c (3)

```

121 /*"FUNC COMMENT"*****
122 * ID :
123 * Module summary: Initial settings for DMA transfer
124 *-----
125 * Include : #include "iodefine.h"
126 *-----
127 * Declaration : io_init_dmal(void *src, void *dst, size_t size, int mode)
128 *-----
129 * Functional description:
130 * : Transfers 'size'-byte data from source address 'src' to destination
131 * : address 'dst' by the DMAC. The transfer is triggered by a request from
132 * : SCIF0. Transfer size and use of interrupt are specified in 'mode'.
133 *-----
134 * Arguments : void *src : Source address
135 * : void *dst : Destination address
136 * : size_t size : Transfer size (byte)
137 * : unsigned int mode : Transfer mode; following modes are specified by
138 * : logical OR.
139 * : DMA_SIZE_BYTE(0x0000) Byte transfer
140 * : DMA_SIZE_WORD(0x0001) Word transfer
141 * : DMA_SIZE_LONG(0x0002) Longword transfer
142 * : DMA_SIZE_LONGx4(0x0003) 16-byte transfer
143 * : DMA_INT_DISABLE(0x0000) DMA transfer-end interrupt is not used.
144 * : DMA_INT_ENABLE(0x0010) DMA transfer-end interrupt is used.
145 *-----
146 * Return valu : None
147 *-----
148 * Note : Correct operation cannot be guaranteed if the transfer data size
149 * : does not agree with alignment of source and destination addresses.
150 * : When an interrupt is used, the corresponding interrupt routine must be
151 prepared.
152 /*"FUNC COMMENT END"*****
153 void io_init_dmal(void *src, void *dst, size_t size, unsigned int mode)
154 {
155     unsigned int ts;
156     unsigned long ie;
157
158     ts = mode & 0x3u;
159     ie = (mode & 0x00f0u) >> 4u;
160
161     /* ==== Setting standby control register 2 (STBCR2) ==== */
162     CPG.STBCR2.BIT.MSTP8 = 0x0; /* Cancel DMAC module stop mode */
163
164     /* ---- Setting DMA channel control register ---- */
165     DMAC.CHCR1.BIT.DE = 0ul; /* Disable DMA transfer */
166
167     /* ---- Setting DMA source address register ---- */
168     DMAC.SAR1.LONG = (unsigned long)src;
169
170     /* ---- Setting DMA reload source address register ---- */
171     DMAC.RSAR1.LONG = (unsigned long)src;
172
173     /* ---- Setting DMA destination address register ---- */
174     DMAC.DAR1.LONG = (unsigned long)dst;
175
176     /* ---- Setting DMA reload destination address register ---- */
177     DMAC.RDAR1.LONG = (unsigned long)dst;

```

5. Sample Program Listing: main.c (4)

```

178     /* ---- Setting DMA transfer count register ---- */
179     /* ---- Setting DMA reload transfer count register ---- */
180
181     if(ts != DMA_SIZE_LONGx4){
182         DMAC.DMATCR1.LONG = size >> ts;           /* Set the number of transfers      */
183         DMAC.RDMATCR1.LONG = size >> ts;
184     }
185     else{
186         DMAC.DMATCR1.LONG = size >> 4u;           /* Set the number of transfers (1/16) */
187         DMAC.RDMATCR1.LONG = size >> 4u;
188     }
189
190     /* ---- Setting DMA channel control register ---- */
191     DMAC.CHCR1.LONG = 0x00001800ul | (mode << 3u) | (ie << 2u) ;
192     /*
193         bit31   : TC DMATCR transfer: 0----- Transfer once
194         bit30-29: reserve 0
195         bit28   : RLD OFF : 0----- Disable reload function
196         bit27-24: reserve 0
197         bit23   : DO over run0 : 0----- Unused
198         bit22   : TL TEND low active : 0----- Unused
199         bit21-20: reserve 0
200         bit19   : HE :0----- Unused
201         bit18   : HIE :0----- Unused
202         bit17   : AM :0----- Unused
203         bit16   : AL :0----- Unused
204         bit15-14: DM1 :0 DM0:0----- Fix destination address
205         bit13-12: SM1 :0 SM0:1----- Increment source address
206         bit11-8  : RS  : auto request : B'1000--- DMA extension resource selector
207         bit7    : DL  : DREQ level : 0 ----- Unused
208         bit6    : DS  : DREQ select :0 Low level- Unused
209         bit5    : TB  :cycle :0----- Cycle steal mode
210         bit4-3  : TS  : transfer size: B'00----- Byte transfer
211         bit2    : IE  : interrupt enable: 0----- Disable interrupt
212         bit1    : TE  : transfer end: 0
213         bit0    : DE  : DMA enable bit: 0----- Disable DMA transfer
214     */
215     /* ---- Setting DMA extension resource selector 0 ---- */
216     DMAC.DMARS0.BIT.CH1MID = 0x20;           /* MID = SCIF0 */
217     DMAC.DMARS0.BIT.CH1RID = 0x01;           /* RID = Transmission      */
218
219     /* ---- Setting DMA operation register ---- */
220     DMAC.DMAOR.WORD &= 0xffff9u;           /* Clear AE, NMIF bits      */
221
222     if(DMAC.DMAOR.BIT.DME == 0ul){           /* Enable DMA transfer on all channels */
223         DMAC.DMAOR.BIT.DME = 1ul;
224     }
225
226     /* ---- DMA transfer execution ---- */
227     DMAC.CHCR1.BIT.DE = 1ul;               /* Enable DMA transfer      */
228
229 }
230

```

5. Sample Program Listing: main.c (5)

```

231 /*"FUNC COMMENT"*****
232 * ID      :
233 * Module summary: Stopping DMAC
234 *-----
235 * Include      : #include "iodefine.h"
236 *-----
237 * Declaration  : void io_dmal_stop(void)
238 *-----
239 * Functional description: Detects the end of DMA transfer and disables DMA transfer.
240 *-----
241 * Argument    : None
242 *-----
243 * Return value : None
244 *-----
245 * Notes       :
246 /*"FUNC COMMENT END"*****/
247 void io_dmal_stop(void)
248 {
249     /* Detecting end of transfer */
250     while(DMAC.CHCR1.BIT.TE == 0ul){
251                                     /* Wait until the TE bit is set      */
252     }
253
254     /* ---- Stopping DMA transfer ---- */
255     DMAC.CHCR1.BIT.DE = 0ul;        /* Disable DMA1 transfer      */
256 }
257

```

6. Sample Program Listing: main.c (6)

```

258 /*"FUNC COMMENT"*****
259 * ID :
260 * Module summary: Initial setting of SCIF0 as an asynchronous (UART) transmit module
261 *-----
262 * Include : #include "iodefine.h"
263 *-----
264 * Declaration : void io_init_scif0(int bps)
265 *-----
266 * Functional description: Initializes SCIF0
267 * : Asynchronous (UART)/ 8 bits / No parity/ 1 stop bit/ RTS/CTS disabled
268 * : Baud rate is specified by argument bps
269 *-----
270 * Argument : int bps : Value for baud rate specification
271 *-----
272 * Return value : None
273 *-----
274 * Notes : The baud rate setting values given in this program are those when
275 * : the peripheral module clock (Pf) frequency is 33 MHz. If a different
276 * : clock is used, the baud rate setting values must be changed.
277 *"FUNC COMMENT END"*****
278 void io_init_scif0(int bps)
279 {
280 /* ==== Power-down mode cancellation ==== */
281 /* ---- Setting Standby control register 4 (STBCR4) ---- */
282 CPG.STBCR4.BIT.MSTP47 = 0; /* Start clock supply to SCIF0 */
283
284 /* ==== SCIF0 initialization ==== */
285 /* ---- Setting serial control register (SCSCRi) ---- */
286 SCIF0.SCSCR.WORD = 0x0000; /* Stop transmission/reception by SCIF0 */
287
288 /* ---- Setting FIFO control register (SCFCRi) ---- */
289 SCIF0.SCFCR.BIT.TFRST = 1; /* Reset transmit FIFO */
290
291 /* ---- Setting serial control register (SCSCRi) ---- */
292 SCIF0.SCSCR.BIT.CKE = 0x0; /* B'00: Internal clock */
293
294 /* ---- Setting serial mode register (SCSMRi) ---- */
295 SCIF0.SCSMR.WORD = scif_baud[bps].scsmr;
296 /* Communication mode 0: Asynchronous mode */
297 /* Character length 0: 8-bit data */
298 /* Parity enable 0: Disable addition and check */
299 /* Parity mode 0: Even parity */
300 /* Stop bit length 0: 1 stop bit */
301 /* Clock select : Table value */
302
303 /* ---- Setting bit rate register (SCBRRi) ---- */
304 SCIF0.SCBRR.BYTE = scif_baud[bps].scbrr;
305
306 /* ---- Setting FIFO control register (SCFCRi) ---- */
307 SCIF0.SCFCR.WORD = 0x0030; /* Transmit FIFO data count trigger: */
308 /* Number of data bytes = 0 */
309 /* Modem control enable : Disabled */
310 /* Transmit FIFO data register reset : Disabled */
311 /* Loopback test : Disabled */
312
313 /* ==== Setting pin function controller (PFC) ==== */
314 PORT.PACRL1.BIT.PA1MD = 1; /* Enable TxD0 pin (PACRL1) */
315
316 /* ---- Setting serial control register (SCSCRi) ---- */
317 SCIF0.SCSCR.BIT.TIE = 1; /* Enable SCIF0 transmit interrupt */
318 SCIF0.SCSCR.BIT.TE = 1; /* Enable SCIF0 transmission */
319
320 }
321 /* End of File */

```

4. Reference Documents

- SH-2A SH2A-FPU Software Manual (Rev.3.00)
(Download the latest edition from the website of Renesas Technology Corp.)
- SH7206 Group Hardware Manual (Rev. 1.00)
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Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.05.05	—	First edition issued

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